

Docket No.: 050103-0553

**PATENT**

**Reply Under 37 CFR 1.116 - Expedited Procedure - Technology Center 1700**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Rajiv Yadav RANJAN, et al.

Application No.: 10/776,203

Customer No.: 49745

Filed: February 12, 2004

Confirmation No.: 2760

Group Art Unit: 1795

Examiner: McDonald, Rodney Glenn

Title: METHOD & APPARATUS FOR MULTI-STAGE SPUTTER DESPOSITION OF  
UNIFORM THICKNESS LAYERS

**RESPONSE TO OFFICE ACTION UNDER 37 C.F.R. § 1.116**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This is in response to the Office Action dated April 24, 2009

**Remarks** begin on page 2 of this paper.